



# Call for Papers

## NordPac Conference

### June 10 – 12 2025

#### Copenhagen, Denmark

Jointly arranged by:  
IMAPS Nordic  
IEEE EPS Nordic

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We are proud to announce that the NordPac 2025 conference will be held Copenhagen, Denmark. This is a perfect opportunity for you to present your revolutionary work within the field of microelectronic packaging while enjoying the normally beautiful weather in Copenhagen in June.

### Abstract submission

We hereby invite you to prepare an abstract for the conference. For NordPac 2025 we have expanded the possibilities for how you want to present your work. We will open three submission tracks:

- **Track 1** will require a **full paper submission** (4-6 pages). Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. (<http://ieeexplore.ieee.org/>).
- **Track 2** will only require an **extended abstract** (1-2 pages) and will only be published in the conference proceedings.
- **Track 3** is reserved for **commercial white papers** (1-4 pages) and will only be published in the conference proceedings. Presentations from all three tracks can appear in the same technical session.

The abstract submission **deadline for all three tracks is January 31<sup>st</sup>, 2025.**

Acceptance will be given within February 28<sup>th</sup>. After this, the three tracks follow different submission deadlines as indicated in the table below.

For full instructions on how to submit your paper and information on review process flow, please go to [www.nordpac.org](http://www.nordpac.org)

### Summary of deadlines

Conference portal open for submission	October 2024
<b>Abstract submission</b>	<b>January 31<sup>st</sup>, 2025</b>
Feedback on abstract	February 28 <sup>th</sup> , 2025
Track 1 – Full paper submission	April 30 <sup>th</sup> , 2025
Track 2 – Extended abstract submission	May 15 <sup>th</sup> , 2025
Track 3 – Commercial white paper submission	May 15 <sup>th</sup> , 2025
Notification of acceptance of all submissions	June 1 <sup>st</sup> , 2025

#### IMAPS Nordic

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## Topics

Proposed topics of microelectronics and packaging include:

<b>Optoelectronics</b>	<b>Harsh environment Applications</b>
<b>Advanced Packaging</b>	<b>Electronics Reliability &amp; Quality</b>
<b>Materials &amp; Processes</b>	<b>Medical electronics</b>
<b>Power electronics</b>	<b>Wearable electronics</b>
<b>Green Technologies</b>	<b>Printed electronics</b>
<b>Advanced packaging for MEMS &amp; sensors &amp; sensor systems</b>	

## About the conference

The event brand NordPac was introduced in Gothenburg in 2017 as a collaboration between IMAPS Nordic and IEEE Electronics Packaging Society (EPS) Nordic. NordPac prides itself on being a small and specialised conference where networking is easy.

**Reviewed** papers will be submitted for publication in IEEE-Xplore with a licence to publish. The Licence allows the author to retain the copyright for the work and can publish it six months after the work has been published in IEEE-Xplore.

For the latest information about the conference and the exhibition, visit our homepage at [www.nordpac.org](http://www.nordpac.org) or email to [info@nordpac.org](mailto:info@nordpac.org).

### Preliminary program includes:

- **IEEE Distinguished Lecture by John Lau**
- **Photonics workshop**
- **Medical electronics workshop**
- **Keynotes**
- **Technical sessions**
- **Exhibition and Exhibitor presentations**
- **Complementary lunch, welcome reception and conference dinner**



LinkedIn @IMAPSNordic



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